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CONFIRMATION NO. 3533

SERIAL NUMBER 10/044,964	FILING DATE 01/15/2002 RULE	CLASS 700	GROUP ART UNIT 2121 2125	ATTORNEY DOCKET NO. 088941-0203
APPLICANTS Sumio Ogawa, Higashihiroshima-shi, JAPAN; Minoru Ueki, Higashihiroshima-shi, JAPAN; Shinichi Hara, Shimonoseki-shi, JAPAN;				
** CONTINUING DATA THIS APPLICATION IS A DIV OF 09/814,871 03/23/2001 PAT 6,349,240 <i>at 8R 2/4/05</i>				
** FOREIGN APPLICATIONS JAPAN 2000-087480 03/27/2000 <i>at 8R 2/4/05</i>				
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 02/06/2002				
Foreign Priority claimed 35 USC 119 (a-d) conditions met	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after <i>Approval</i>	STATE OR COUNTRY JAPAN	SHEETS DRAWING 23	TOTAL CLAIMS 3 <i>4</i> ✓ INDEPENDENT CLAIMS 1
ADDRESS 22428				
TITLE Method of manufacturing semiconductor devices				
FILING FEE RECEIVED 740	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:			<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit

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